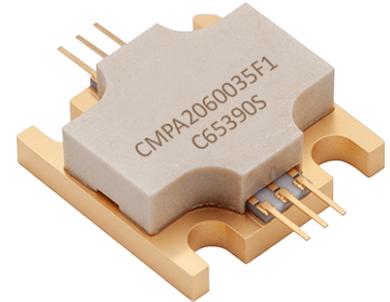


# CMPA2060035F1

35 W, 2.0 - 6.0 GHz, GaN MMIC, Power Amplifier

## Description

The CMPA2060035F1 is a gallium nitride (GaN) high electron mobility transistor (HEMT) based monolithic microwave integrated circuit (MMIC). GaN has superior properties compared to silicon or gallium arsenide, including higher breakdown voltage, higher saturated electron drift velocity and higher thermal conductivity. GaN HEMTs also offer greater power density and wider bandwidths compared to Si and GaAs transistors. This MMIC contains a two-stage 50-ohm matched amplifier, enabling very wide bandwidths to be achieved, in a small 0.5" square, screw-down package.



Package Types: 440219  
PN's: CMPA2060035F1

### Features

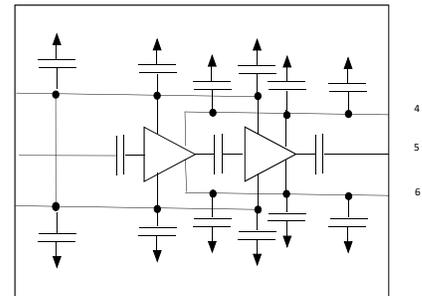
- >30% typical power added efficiency
- 30 dB small signal gain
- 36 W typical  $P_{SAT}$
- Operation up to 28 V
- High breakdown voltage
- High temperature operation

**Note:**

Features represent typical performance across multiple frequencies under 25 °C operation. Please reference the performance charts for additional details.

### Applications

- Civil and military pulsed radar amplifiers
- Test instrumentation
- Electronic warfare jamming



## Typical Performance Over 2.0 - 6.0 GHz ( $T_c = 25\text{ }^\circ\text{C}$ )

Parameter	2.0 GHz	3.0 GHz	4.0 GHz	5.0 GHz	6.0 GHz	Units
Small Signal Gain <sup>1,2</sup>	30.0	29.4	30.4	32.0	27.5	dB
Output Power <sup>1,3</sup>	45.6	46.2	45.7	46.2	44.4	dBm
Power Gain <sup>1,3</sup>	23.6	24.2	23.7	24.2	22.4	dB
Power Added Efficiency <sup>1,3</sup>	52	48	38	35	30	%

**Notes:**

<sup>1</sup>  $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 1000\text{ mA}$ .

<sup>2</sup> Measured at  $P_{IN} = -20\text{ dBm}$ .

<sup>3</sup> Measured at  $P_{IN} = 22\text{ dBm}$  and CW.



### Absolute Maximum Ratings (Not Simultaneous) at 25 °C

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	$V_{DSS}$	84	$V_{DC}$	25 °C
Gate-Source Voltage	$V_{GS}$	-10, +2	$V_{DC}$	25 °C
Storage Temperature	$T_{STG}$	-55, +150	°C	
Maximum Forward Gate Current	$I_G$	16.32	mA	25 °C
Maximum Drain Current	$I_{DMAX}$	4.0	A	
Soldering Temperature	$T_S$	260	°C	

### Electrical Characteristics (Frequency = 2.0 GHz to 6.0 GHz Unless Otherwise Stated; $T_c = 25 °C$ )

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
<b>DC Characteristics</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	-2.6	-2.0	-1.6	V	$V_{DS} = 10 V, I_D = 16.32 mA$
Gate Quiescent Voltage	$V_{GS(Q)}$	-	-1.8	-	$V_{DC}$	$V_{DD} = 28 V, I_{DQ} = 1000 mA$
Saturated Drain Current <sup>1</sup>	$I_{DS}$	16.32	19.58	-	A	$V_{DS} = 6.0 V, V_{GS} = 2.0 V$
Drain-Source Breakdown Voltage	$V_{BD}$	84	-	-	V	$V_{GS} = -8 V, I_D = 16.32 mA$
<b>RF Characteristics</b>						
Small Signal Gain	$S_{21_1}$	-	30.0	-	dB	$P_{IN} = -20 dBm, Freq = 2.0 - 6.0 GHz$
Output Power <sup>2</sup>	$P_{OUT1}$	-	45.6	-	dBm	$V_{DD} = 28 V, I_{DQ} = 1000 mA, P_{IN} = 22 dBm, Freq = 2.0 GHz$
Output Power <sup>2</sup>	$P_{OUT2}$	-	46.2	-	dBm	$V_{DD} = 28 V, I_{DQ} = 1000 mA, P_{IN} = 22 dBm, Freq = 3.0 GHz$
Output Power <sup>2</sup>	$P_{OUT3}$	-	45.7	-	dBm	$V_{DD} = 28 V, I_{DQ} = 1000 mA, P_{IN} = 22 dBm, Freq = 4.0 GHz$
Output Power <sup>2</sup>	$P_{OUT4}$	-	46.2	-	dBm	$V_{DD} = 28 V, I_{DQ} = 1000 mA, P_{IN} = 22 dBm, Freq = 5.0 GHz$
Output Power <sup>2</sup>	$P_{OUT5}$	-	44.4	-	dBm	$V_{DD} = 28 V, I_{DQ} = 1000 mA, P_{IN} = 22 dBm, Freq = 6.0 GHz$
Power Added Efficiency <sup>2</sup>	$PAE_1$	-	52	-	%	$V_{DD} = 28 V, I_{DQ} = 1000 mA, P_{IN} = 22 dBm, Freq = 2.0 GHz$
Power Added Efficiency <sup>2</sup>	$PAE_2$	-	48	-	%	$V_{DD} = 28 V, I_{DQ} = 1000 mA, P_{IN} = 22 dBm, Freq = 3.0 GHz$
Power Added Efficiency <sup>2</sup>	$PAE_3$	-	38	-	%	$V_{DD} = 28 V, I_{DQ} = 1000 mA, P_{IN} = 22 dBm, Freq = 4.0 GHz$
Power Added Efficiency <sup>2</sup>	$PAE_4$	-	35	-	%	$V_{DD} = 28 V, I_{DQ} = 1000 mA, P_{IN} = 22 dBm, Freq = 5.0 GHz$
Power Added Efficiency <sup>2</sup>	$PAE_5$	-	30	-	%	$V_{DD} = 28 V, I_{DQ} = 1000 mA, P_{IN} = 22 dBm, Freq = 6.0 GHz$
Power Gain	$G_{P1}$	-	23.6	-	dB	$V_{DD} = 28 V, I_{DQ} = 1000 mA, P_{IN} = 22 dBm, Freq = 2.0 GHz$
Power Gain	$G_{P2}$	-	24.2	-	dB	$V_{DD} = 28 V, I_{DQ} = 1000 mA, P_{IN} = 22 dBm, Freq = 3.0 GHz$
Power Gain	$G_{P3}$	-	23.7	-	dB	$V_{DD} = 28 V, I_{DQ} = 1000 mA, P_{IN} = 22 dBm, Freq = 4.0 GHz$
Power Gain	$G_{P4}$	-	24.2	-	dB	$V_{DD} = 28 V, I_{DQ} = 1000 mA, P_{IN} = 22 dBm, Freq = 5.0 GHz$
Power Gain	$G_{P5}$	-	22.4	-	dB	$V_{DD} = 28 V, I_{DQ} = 1000 mA, P_{IN} = 22 dBm, Freq = 6.0 GHz$
Input Return Loss	S11	-	-14	-	dB	$P_{IN} = -20 dBm, 2.0 - 6.0 GHz$
Output Return Loss	S22	-	-14	-	dB	$P_{IN} = -20 dBm, 2.0 - 6.0 GHz$
Output Mismatch Stress	VSWR	-	-	5:1	$\Psi$	No Damage at All Phase Angles

Notes:

<sup>1</sup> Scaled from PCM data.

<sup>2</sup> Performance is based on production testing at a fixed input power. To see performance where the input power is optimized for either maximum output power or power added efficiency, see Figures 46 and 47.

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Rev. 0.3, SEPTEMBER 2023

## Thermal Characteristics

Parameter	Symbol	Rating	Units	Conditions
Operating Junction Temperature	$T_J$	225	°C	
Thermal Resistance, Junction to Case (Packaged) <sup>1</sup>	$R_{\theta JC}$	1.5	°C/W	CW

Note:

<sup>1</sup> For the CMPA2060035F1 at  $P_{DISS} = 89$  W.

### Typical Performance of the CMPA2060035F1

Test conditions unless otherwise noted:  $V_D = 28\text{ V}$ ,  $I_{DQ} = 1000\text{ mA}$ , CW,  $P_{IN} = 22\text{ dBm}$ ,  $T_{BASE} = +25\text{ }^\circ\text{C}$

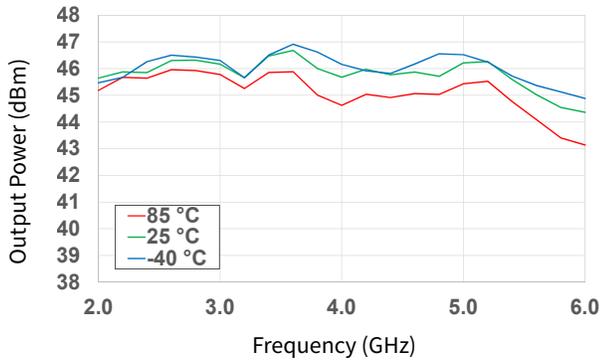


Figure 1. Output Power vs Frequency as a Function of Temperature

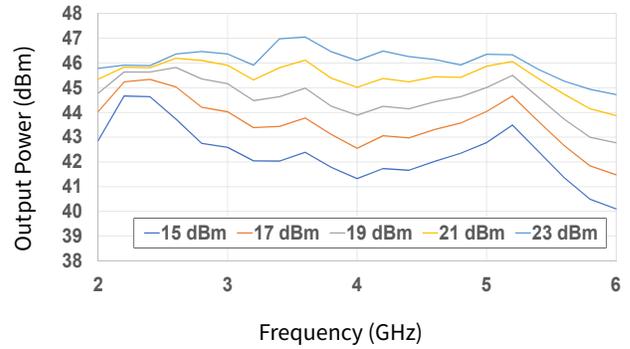


Figure 2. Output Power vs Frequency as a Function of Input Power

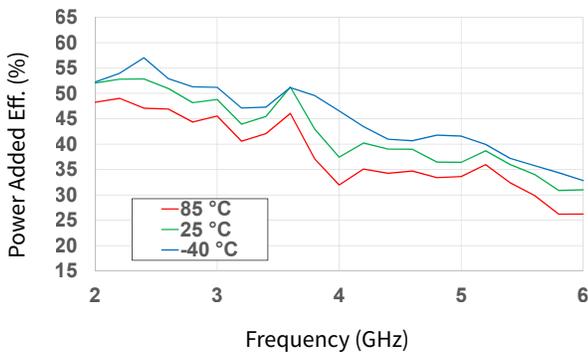


Figure 3. Power Added Eff. vs Frequency as a Function of Temperature

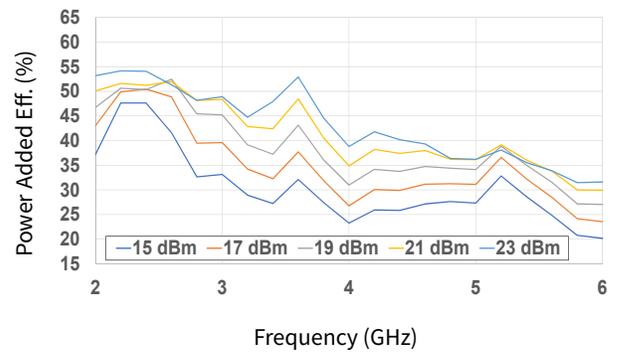


Figure 4. Power Added Eff. vs Frequency as a Function of Input Power

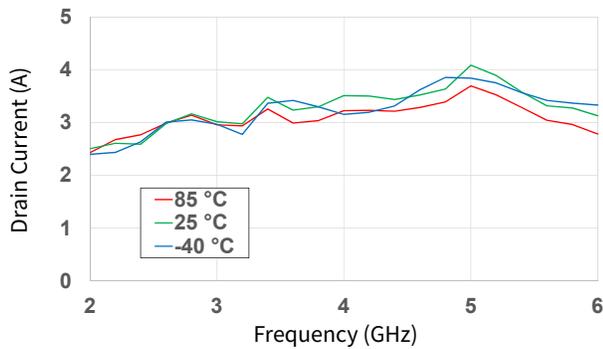


Figure 5. Drain Current vs Frequency as a Function of Temperature

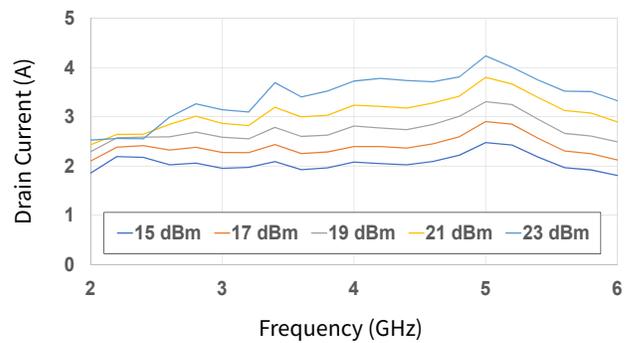


Figure 6. Drain Current vs Frequency as a Function of Input Power

### Typical Performance of the CPMA2060035F1

Test conditions unless otherwise noted:  $V_D = 28\text{ V}$ ,  $I_{DQ} = 1000\text{ mA}$ , CW,  $P_{IN} = 22\text{ dBm}$ ,  $T_{BASE} = +25\text{ }^\circ\text{C}$

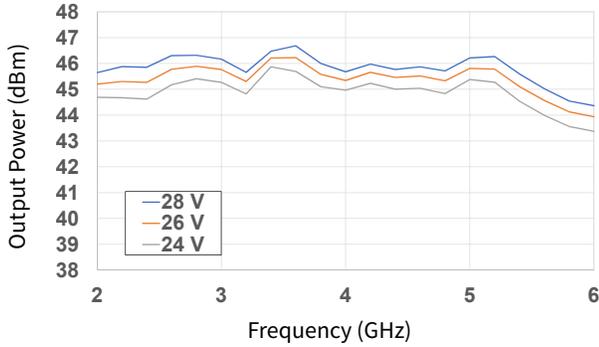


Figure 7. Output Power vs Frequency as a Function of  $V_D$

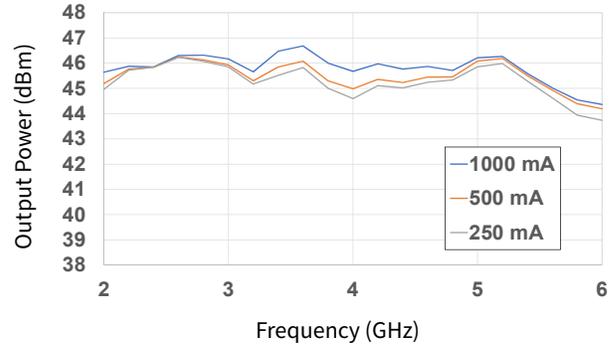


Figure 8. Output Power vs Frequency as a Function of  $I_{DQ}$

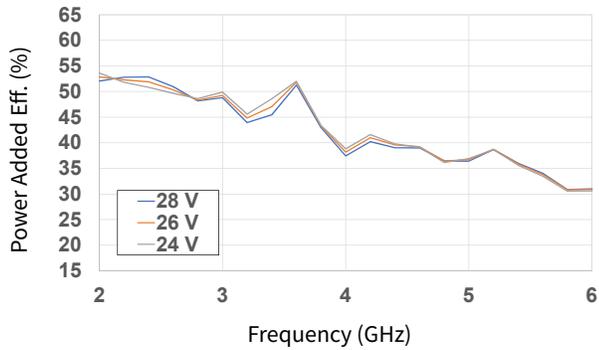


Figure 9. Power Added Eff. vs Frequency as a Function of  $V_D$

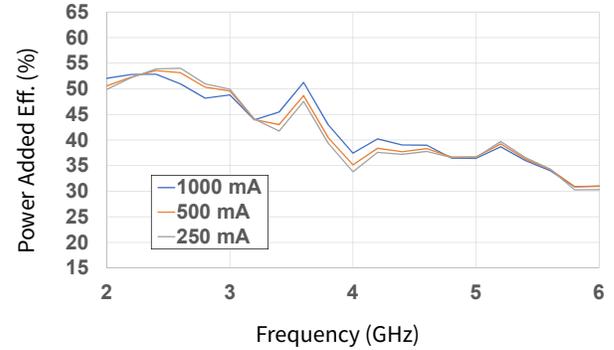


Figure 10. Power Added Eff. vs Frequency as a Function of  $I_{DQ}$

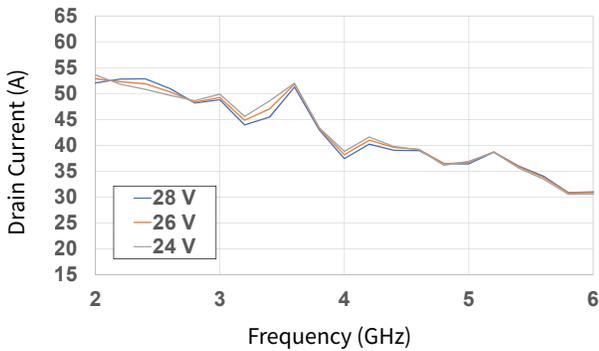


Figure 11. Drain Current vs Frequency as a Function of  $V_D$

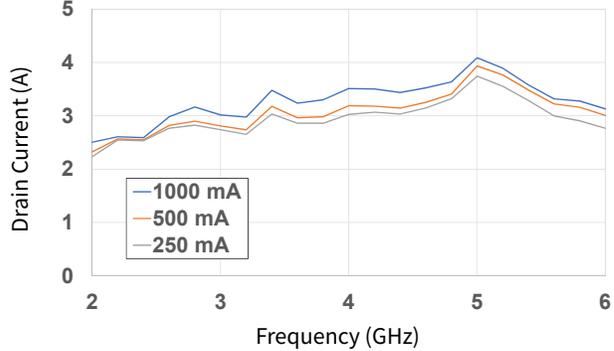


Figure 12. Drain Current vs Frequency as a Function of  $I_{DQ}$

### Typical Performance of the CPMA2060035F1

Test conditions unless otherwise noted:  $V_D = 28\text{ V}$ ,  $I_{DQ} = 1000\text{ mA}$ , CW,  $P_{IN} = 22\text{ dBm}$ ,  $T_{BASE} = +25\text{ }^\circ\text{C}$

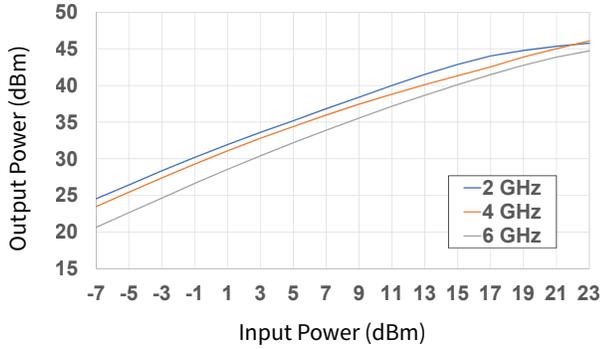


Figure 13. Output Power vs Input Power as a Function of Frequency

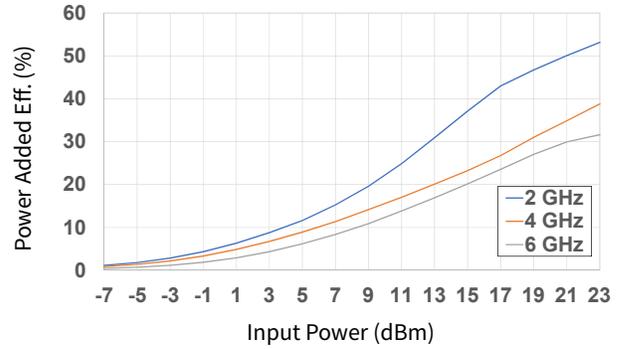


Figure 14. Power Added Eff. vs Input Power as a Function of Frequency

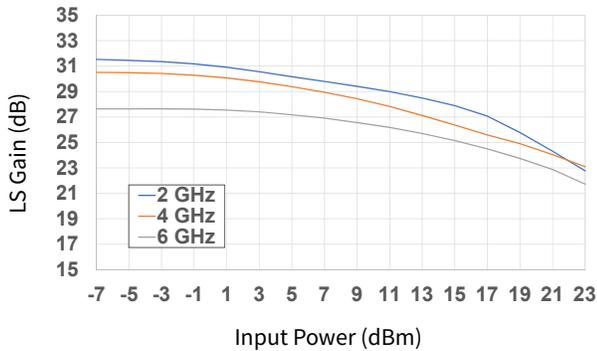


Figure 15. Large Signal Gain vs Input Power as a Function of Frequency

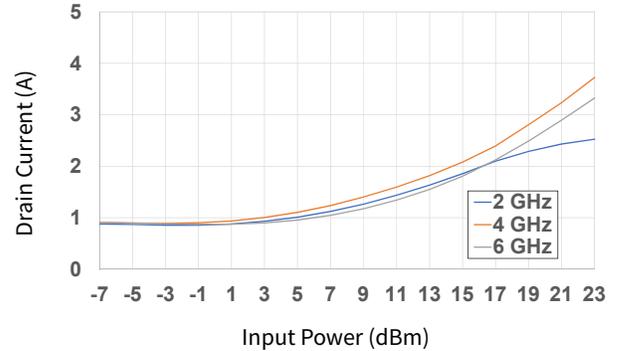


Figure 16. Drain Current vs Input Power as a Function of Frequency

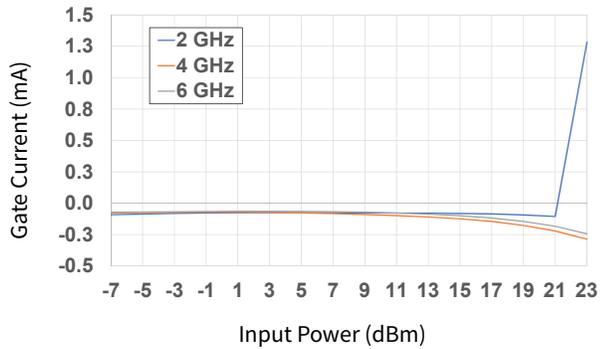


Figure 17. Gate Current vs Input Power as a Function of Frequency

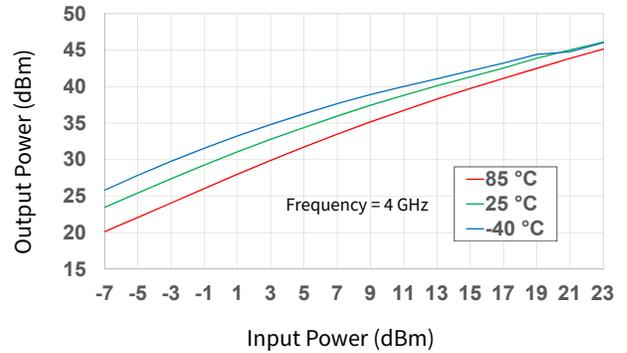


Figure 18. Output Power vs Input Power as a Function of Temperature

### Typical Performance of the CPMA2060035F1

Test conditions unless otherwise noted:  $V_D = 28\text{ V}$ ,  $I_{DQ} = 1000\text{ mA}$ , CW,  $P_{IN} = 22\text{ dBm}$ ,  $T_{BASE} = +25\text{ }^\circ\text{C}$

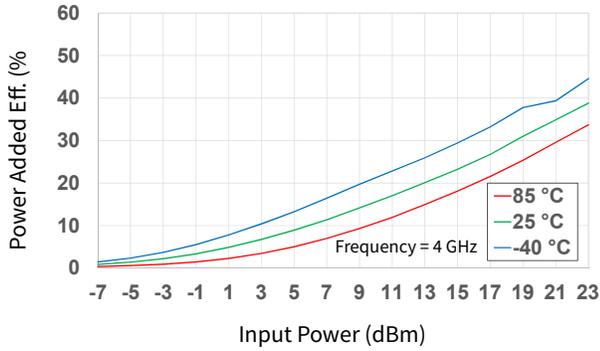


Figure 19. Power Added Eff. vs Input Power as a Function of Temperature

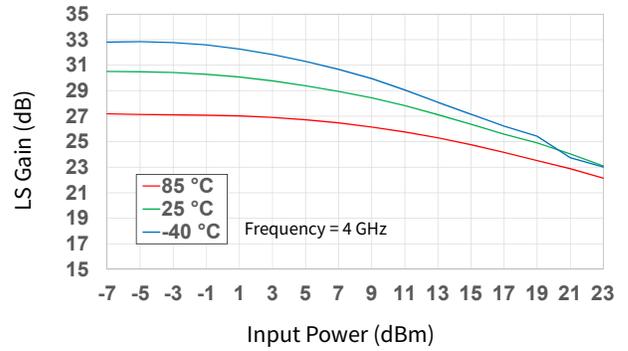


Figure 20. Large Signal Gain vs Input Power as a Function of Temperature

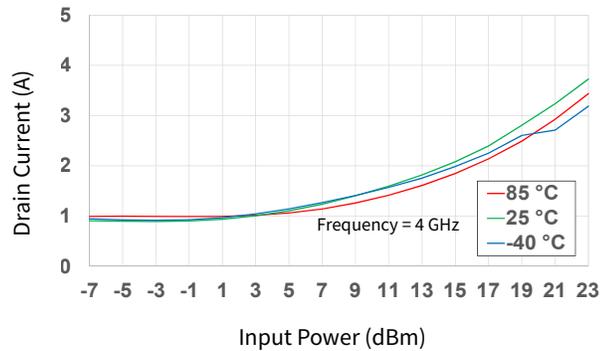


Figure 21. Drain Current vs Input Power as a Function of Temperature

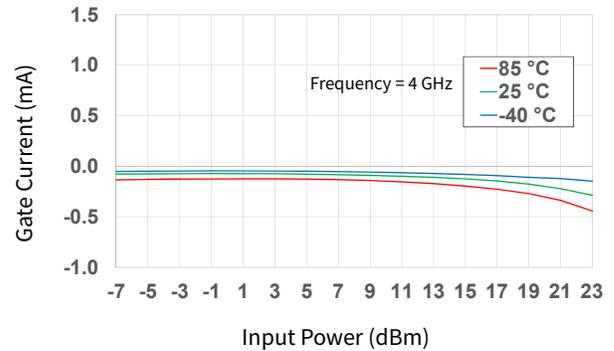


Figure 22. Gate Current vs Input Power as a Function of Temperature

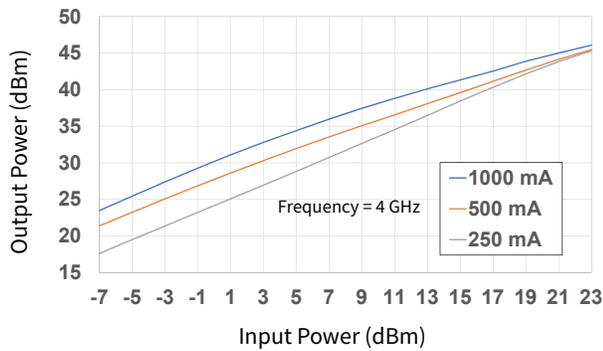


Figure 23. Output Power vs Input Power as a Function of  $I_{DQ}$

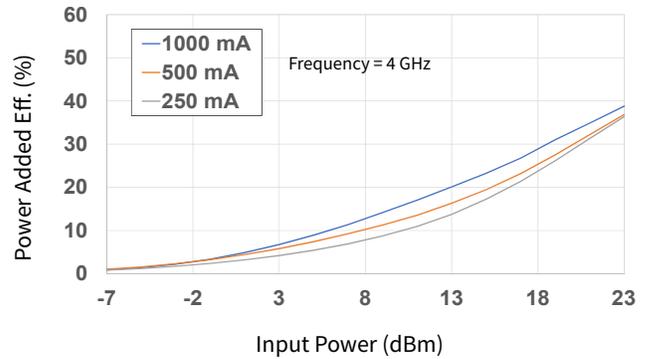


Figure 24. Power Added Eff. vs Input Power as a Function of  $I_{DQ}$

### Typical Performance of the CPMA2060035F1

Test conditions unless otherwise noted:  $V_D = 28\text{ V}$ ,  $I_{DQ} = 1000\text{ mA}$ , CW,  $P_{IN} = 22\text{ dBm}$ ,  $T_{BASE} = +25\text{ }^\circ\text{C}$

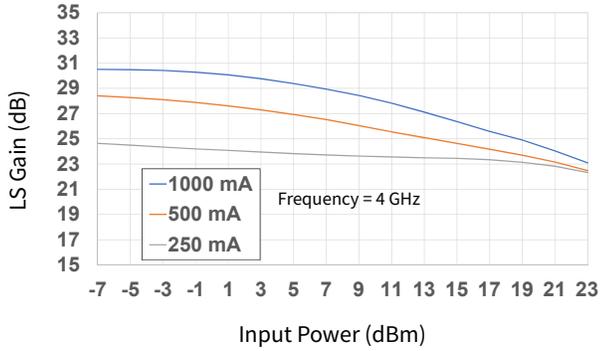


Figure 25. Large Signal Gain vs Input Power as a Function of  $I_{DQ}$

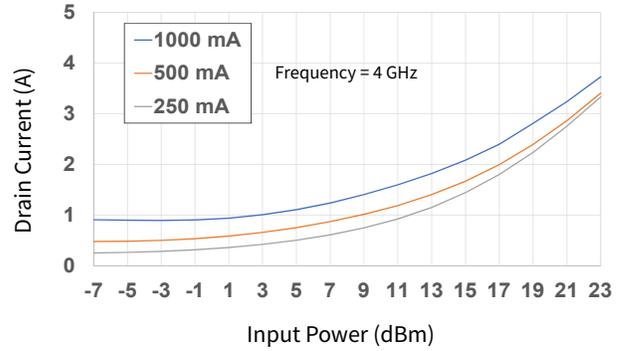


Figure 26. Drain Current vs Input Power as a Function of  $I_{DQ}$

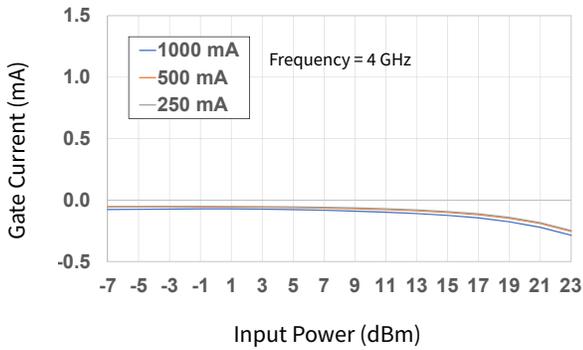


Figure 27. Gate Current vs Input Power as a Function of  $I_{DQ}$

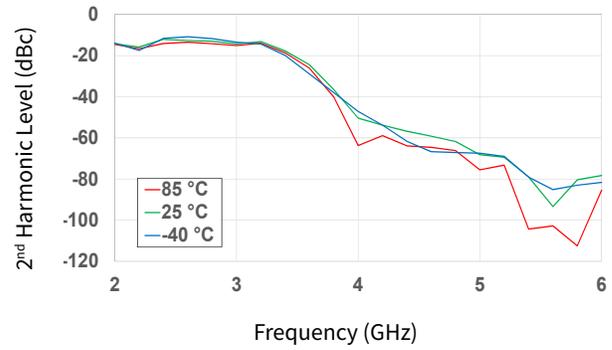


Figure 28. 2<sup>nd</sup> Harmonic vs Frequency as a Function of Temperature

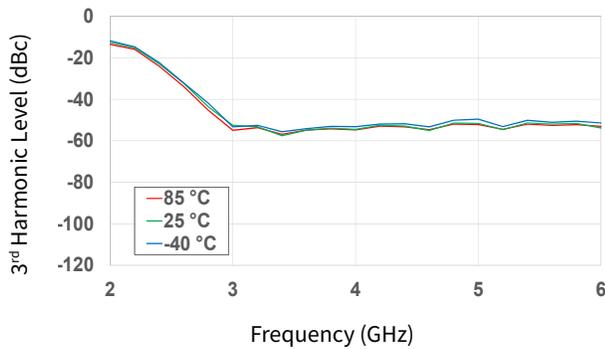


Figure 29. 3<sup>rd</sup> Harmonic vs Frequency as a Function of Temperature

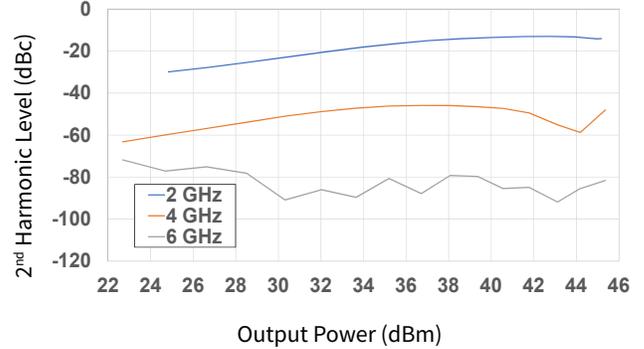


Figure 30. 2<sup>nd</sup> Harmonic vs Output Power as a Function of Frequency

### Typical Performance of the CPMA2060035F1

Test conditions unless otherwise noted:  $V_D = 28\text{ V}$ ,  $I_{DQ} = 1000\text{ mA}$ , CW,  $P_{IN} = 22\text{ dBm}$ ,  $T_{BASE} = +25\text{ }^\circ\text{C}$

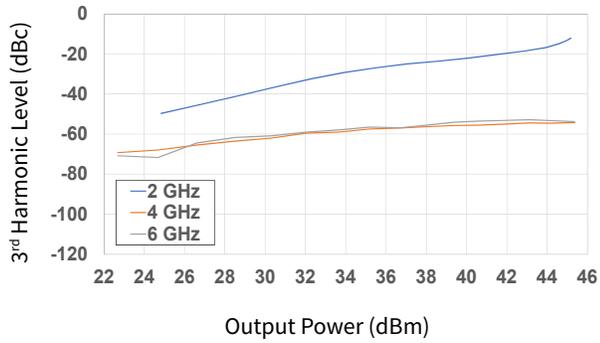


Figure 31. 3<sup>rd</sup> Harmonic vs Output Power as a Function of Frequency

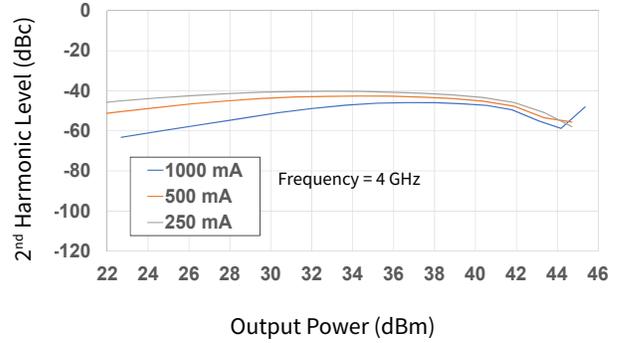


Figure 32. 2<sup>nd</sup> Harmonic vs Output Power as a Function of  $I_{DQ}$

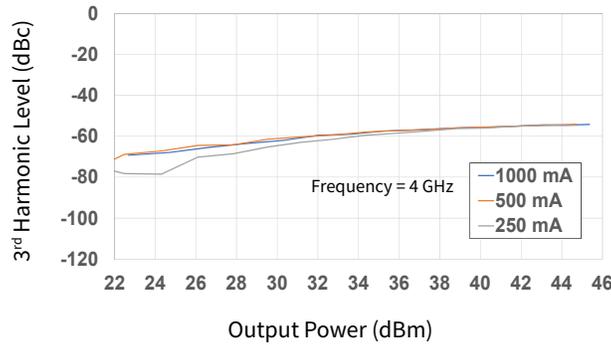


Figure 33. 3<sup>rd</sup> Harmonic vs Output Power as a Function of  $I_{DQ}$

### Typical Performance of the CPMA2060035F1

Test conditions unless otherwise noted:  $V_D = 28\text{ V}$ ,  $I_{DQ} = 1000\text{ mA}$ ,  $P_{IN} = -20\text{ dBm}$ ,  $T_{BASE} = +25\text{ }^\circ\text{C}$

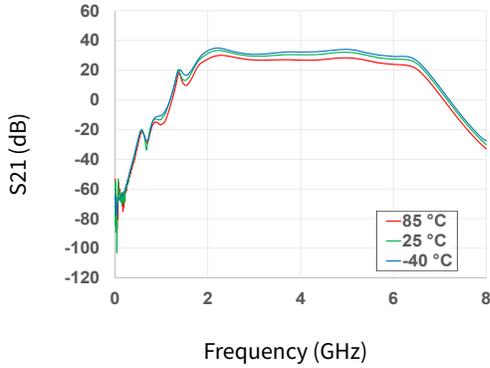


Figure 34. Gain vs Frequency as a Function of Temperature

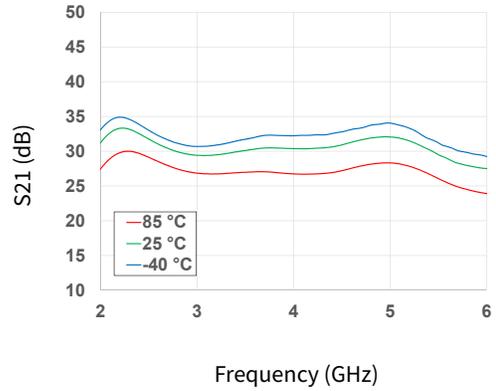


Figure 35. Gain vs Frequency as a Function of Temperature

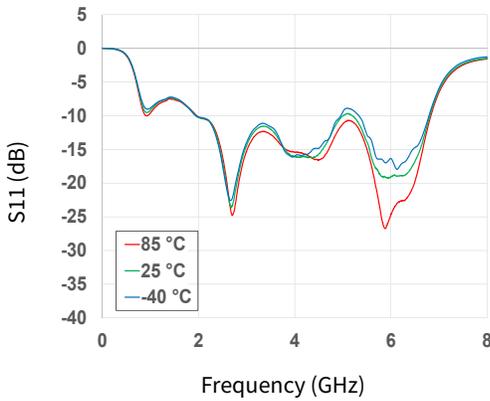


Figure 36. Input RL vs Frequency as a Function of Temperature

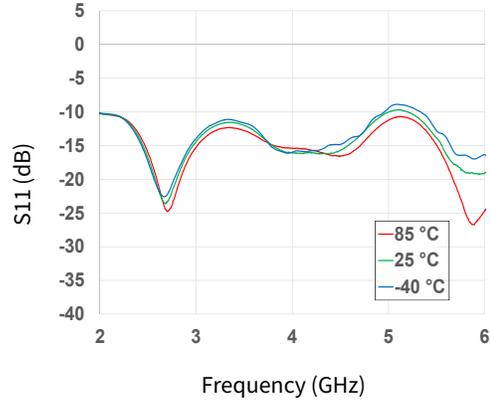


Figure 37. Input RL vs Frequency as a Function of Temperature

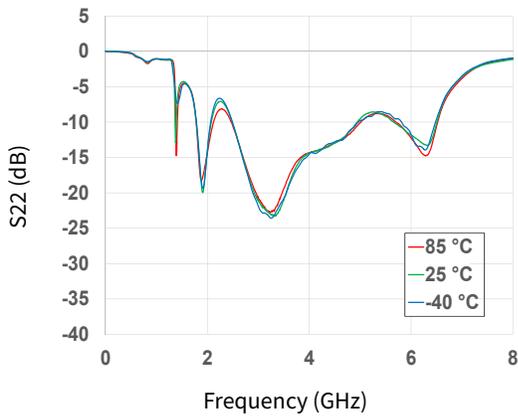


Figure 38. Output RL vs Frequency as a Function of Temperature

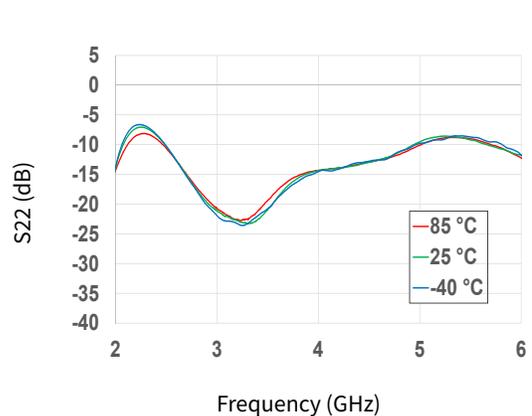


Figure 39. Output RL vs Frequency as a Function of Temperature

### Typical Performance of the CMPA2060035F1

Test conditions unless otherwise noted:  $V_D = 28\text{ V}$ ,  $I_{DQ} = 1000\text{ mA}$ ,  $P_{IN} = -20\text{ dBm}$ ,  $T_{BASE} = +25\text{ }^\circ\text{C}$

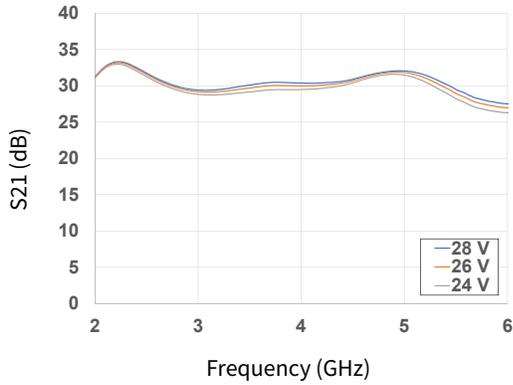


Figure 40. Gain vs Frequency as a Function of Voltage

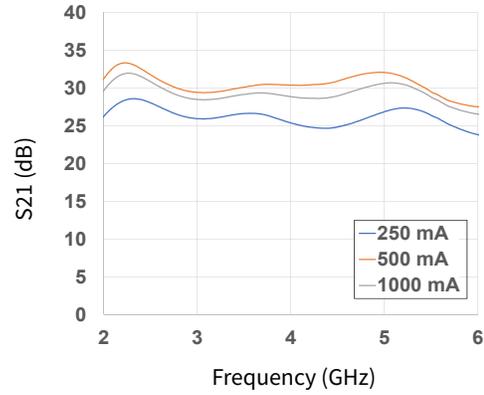


Figure 41. Gain vs Frequency as a Function of Voltage

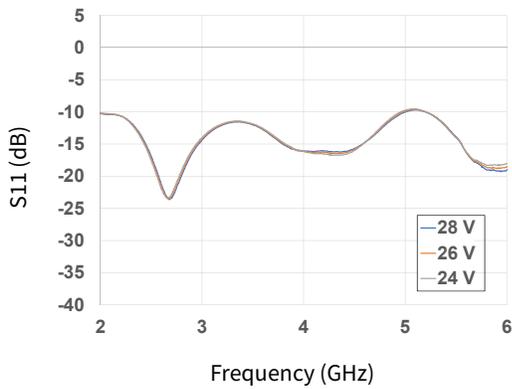


Figure 42. Input RL vs Frequency as a Function of Voltage

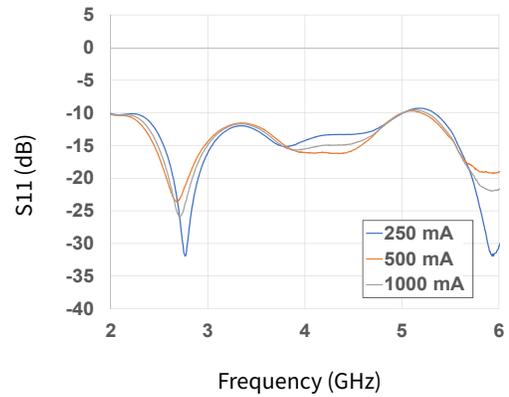


Figure 43. Input RL vs Frequency as a Function of  $I_{DQ}$

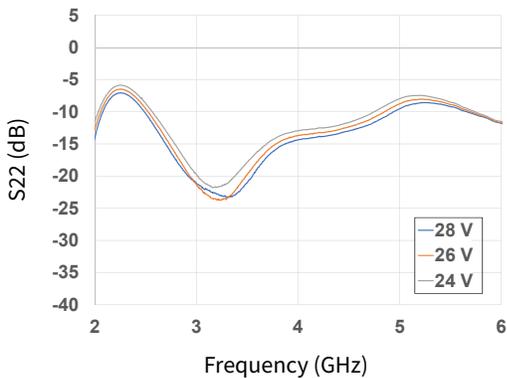


Figure 44. Output RL vs Frequency as a Function of Voltage

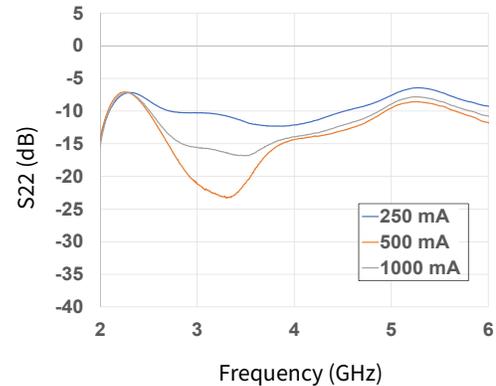


Figure 45. Output RL vs Frequency as a Function of  $I_{DQ}$

### Typical Performance of the CMPA2060035F1

Test conditions unless otherwise noted:  $V_D = 28\text{ V}$ ,  $I_{DQ} = 1000\text{ mA}$ ,  $P_{IN} = -20\text{ dBm}$ ,  $T_{BASE} = +25\text{ }^\circ\text{C}$

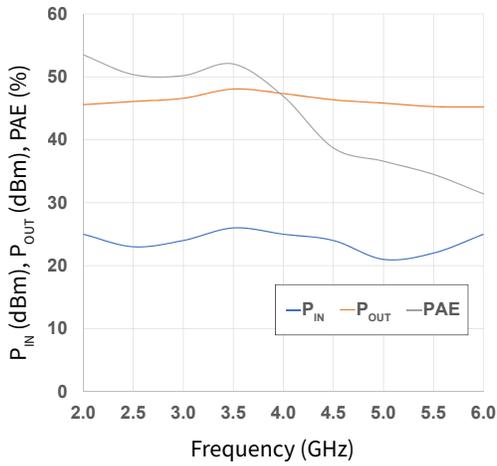


Figure 46. Output Power and Power Added Eff. vs Frequency when Optimized for Maximum PAE

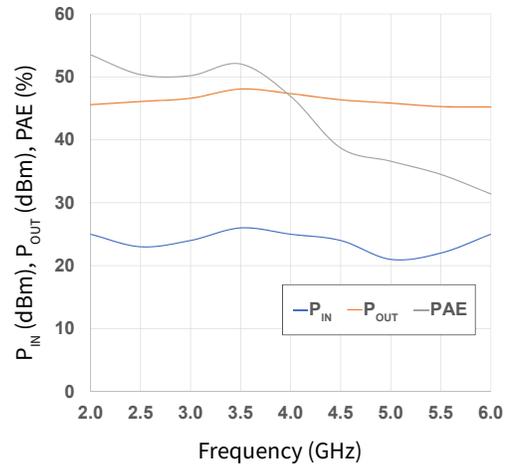
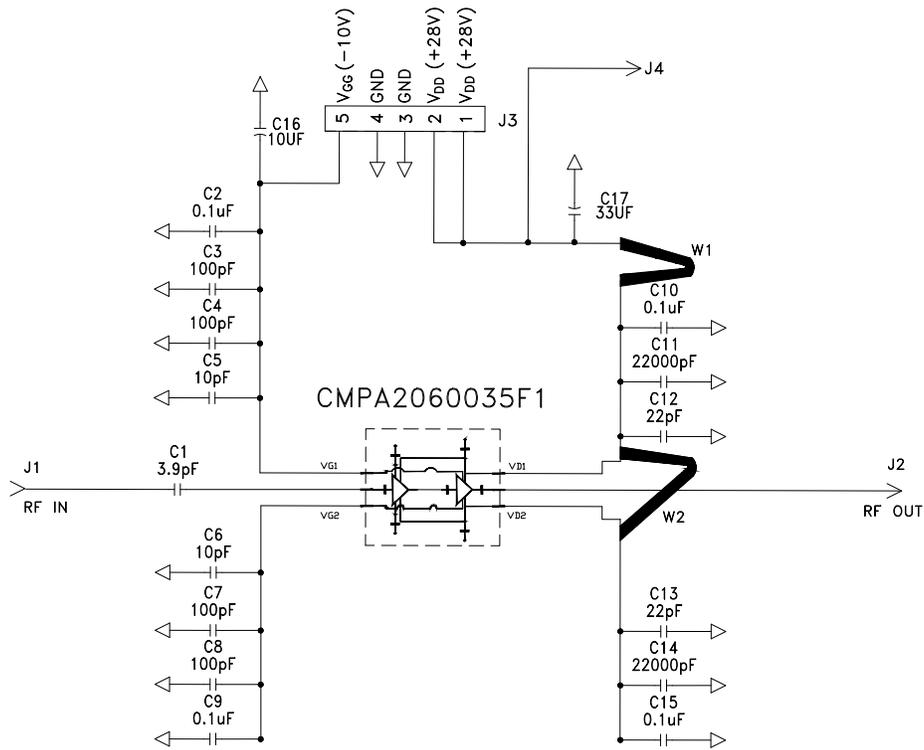
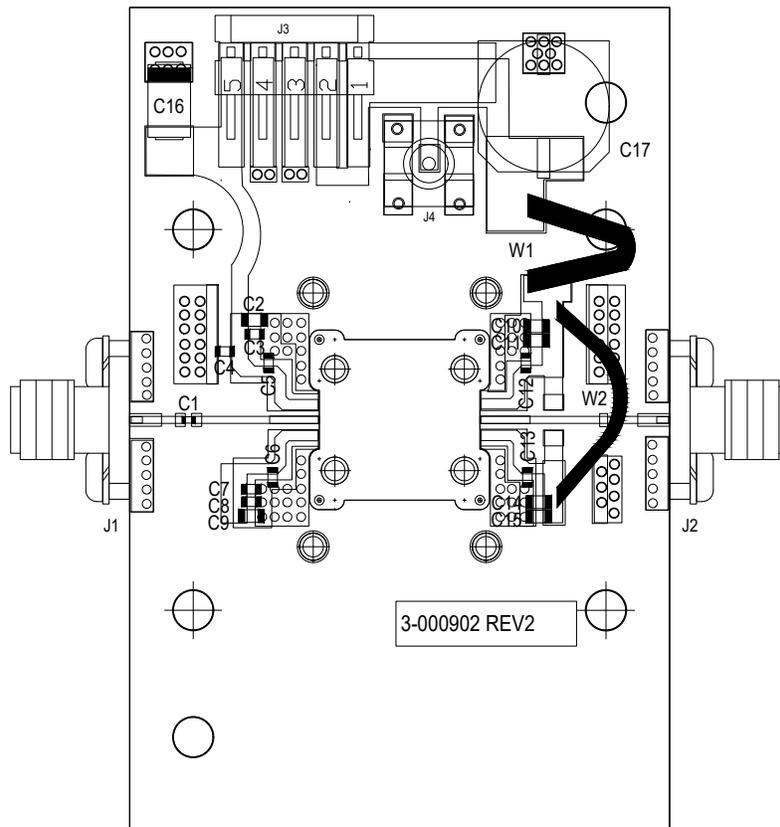


Figure 47. Output Power and Power Added Eff. vs Frequency when Optimized for Maximum Output Power

### CMPA2060035F1-AMP Evaluation Board Schematic



### CMPA2060035F1-AMP Evaluation Board Outline



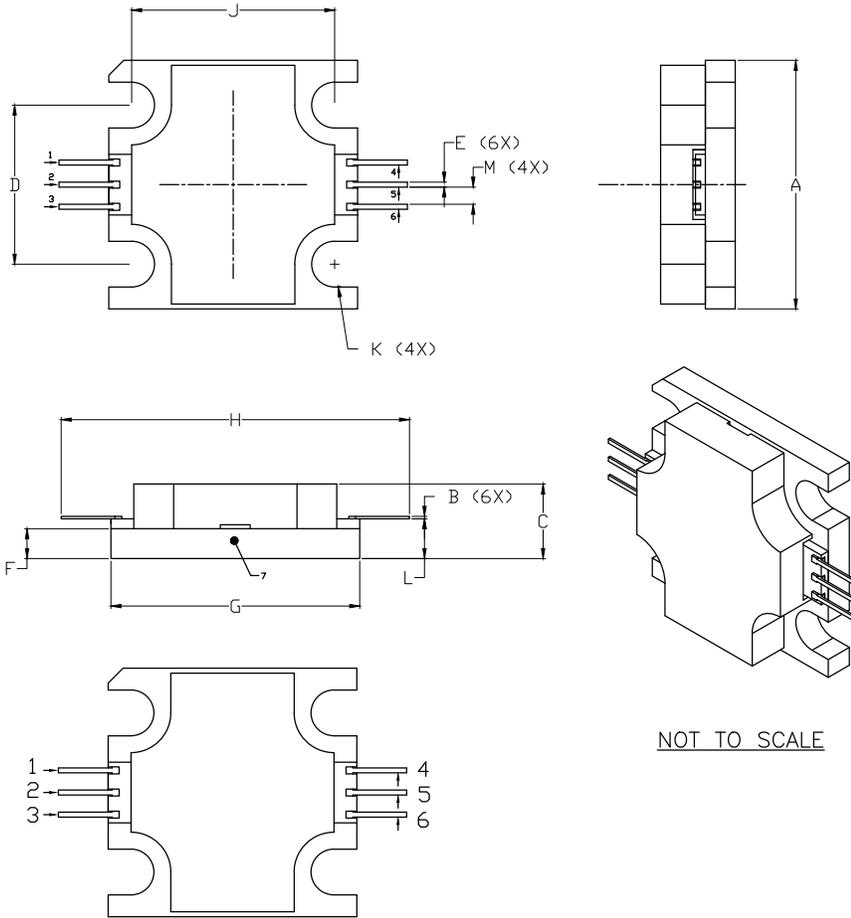
## CMPA2060035F1-AMP Evaluation Board Bill of Materials

Designator	Description	Qty
C1	CAP, 3.9 pF, +/-0.1 pF, 0402, ATC	1
C11, C14	CAP CER 22,000 PF 100 V 10% X7R 0805	2
C12, C13	CAP, 22 pF, +/-5%, 0603, ATC	2
C16	CAP 10 UF 16 V TANTALUM, 2312	1
C17	CAP, 33 UF, 20%, G CASE	1
C2, C9, C10, C15	CAP CER 0.1 UF 100 V 10% X7R 0805	4
C3, C4, C7, C8	CAP, 100.0 pF, +/-5%, 0603, ATC	4
C5, C6	CAP, 10.0 pF, +/-5%, 0603, ATC	2
J1, J2	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4-HOLE, BLUNT POST, 20 MIL	2
J3	HEADER RT>PLZ .1CEN LK 5POS	1
J4	CONN, SMB, STRAIGHT JACK RECEPTACLE, SMT, 50 OHM, Au PLATED	1
W1, W2	WIRE, BLACK, 22 AWG	2
	TEST FIXTURE, 2-6 GHz, CMPA2060035F1	1
	PCB board 2.6" X 1.7", TACONIC RF 35, 0.01", 440219 Package	1
	BASEPLATE, AL, 2.60 X 1.70 X 2.50	1
Q1	CMPA2060035F1: GaN, MMIC PA, 35 W, 2-6 GHz, Flange	1

## Electrostatic Discharge (ESD) Classifications

Parameter	Symbol	Class	Test Methodology
Human Body Model	HBM	1 B ( $\geq 500$ V)	JEDEC JESD22 A114-D
Charge Device Model	CDM	II ( $\geq 200$ V)	JEDEC JESD22 C101-C

**Product Dimensions CMPA2060035F1 (Package 440219 )**



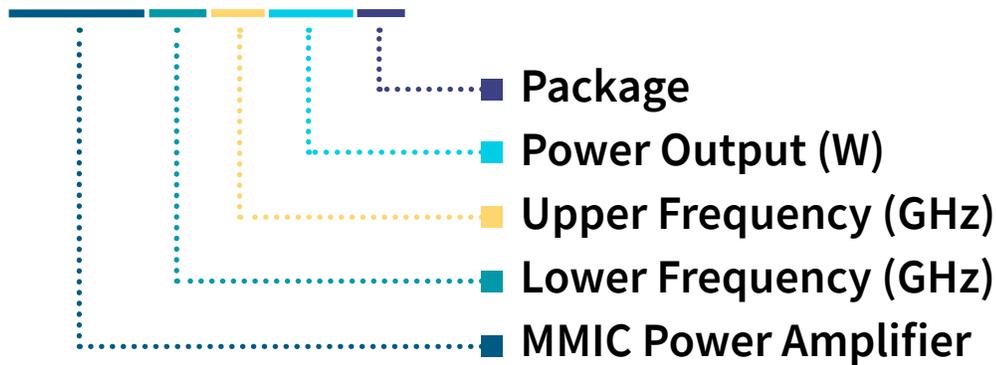
NOT TO SCALE

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.495	0.505	12.57	12.82
B	0.003	0.005	0.076	0.127
C	0.140	0.160	3.56	4.06
D	0.315	0.325	8.00	8.25
E	0.008	0.012	0.204	0.304
F	0.055	0.065	1.40	1.65
G	0.495	0.505	12.57	12.82
H	0.695	0.705	17.65	17.91
J	0.403	0.413	10.24	10.49
K	∅ .092		2.34	
L	0.075	0.085	1.905	2.159
M	0.032	0.040	0.82	1.02

Pin	Desc.
1	Gate 1
2	RF_IN
3	Gate 2
4	Drain 1
5	RF_OUT
6	Drain 2

**Part Number System**

**CMPA2060035F1**



**Table 1.**

Parameter	Value	Units
Lower Frequency	2.0	GHz
Upper Frequency	6.0	GHz
Power Output	35	W
Package	Flange	-

Note:  
 Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

**Table 2.**

Character Code	Code Value
A	0
B	1
C	2
D	3
E	4
F	5
G	6
H	7
J	8
K	9
Examples:	1 A = 10.0 GHz 2 H = 27.0 GHz

**Product Ordering Information**

Order Number	Description	Unit of Measure	Image
CMPA2060035F1	GaN HEMT	Each	
CMPA2060035F1-AMP	Test Board with GaN MMIC Installed	Each	

## Notes & Disclaimer

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